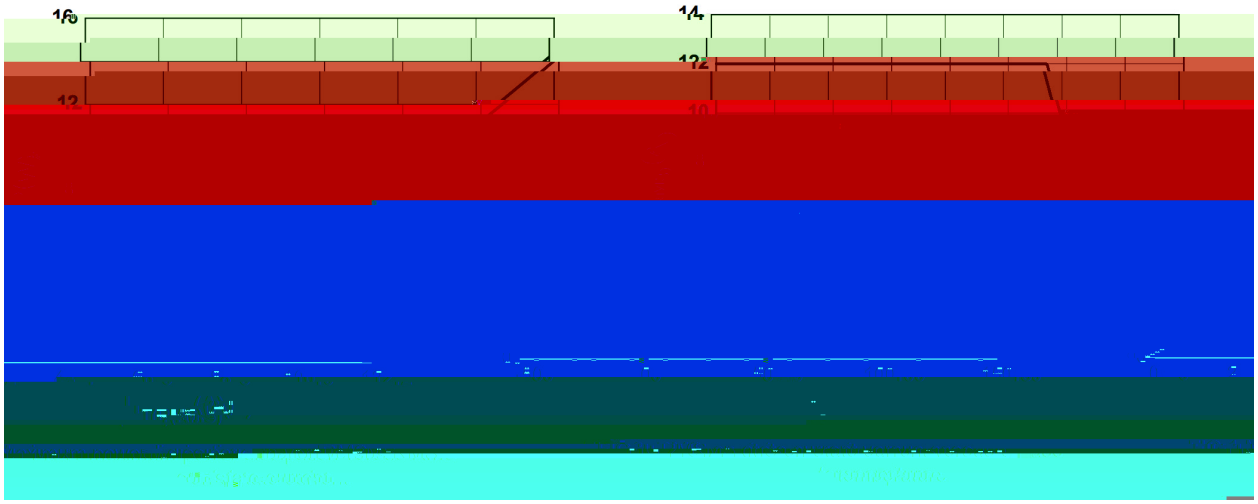
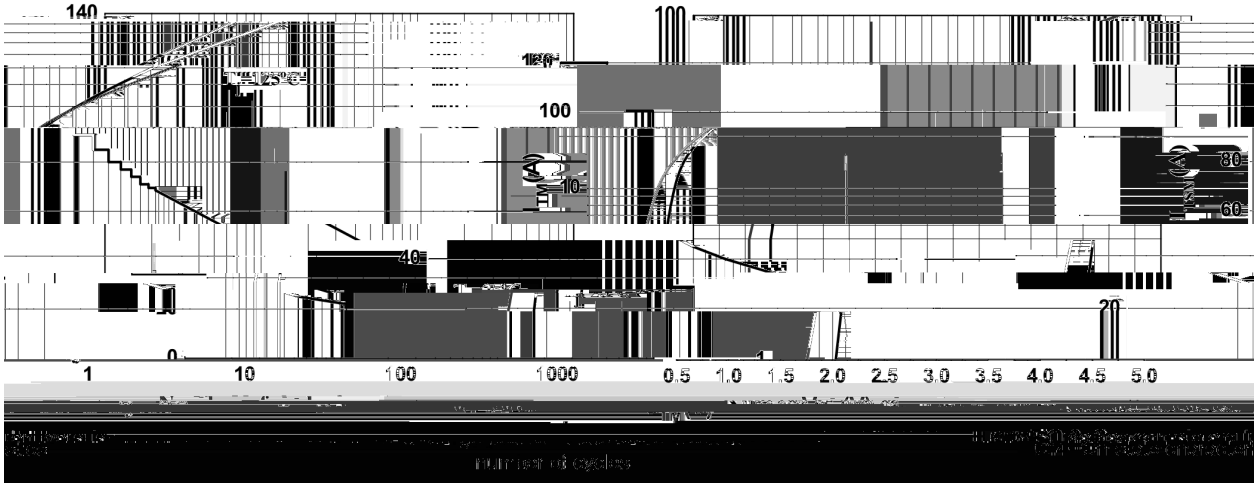
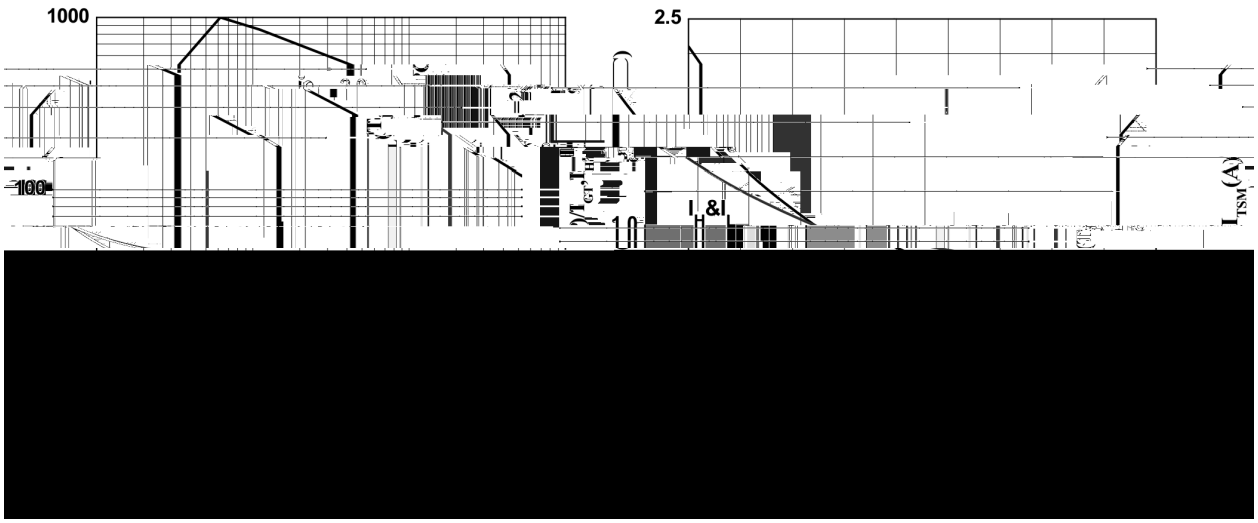
: 5 , .> / / x E g U OJ´ož

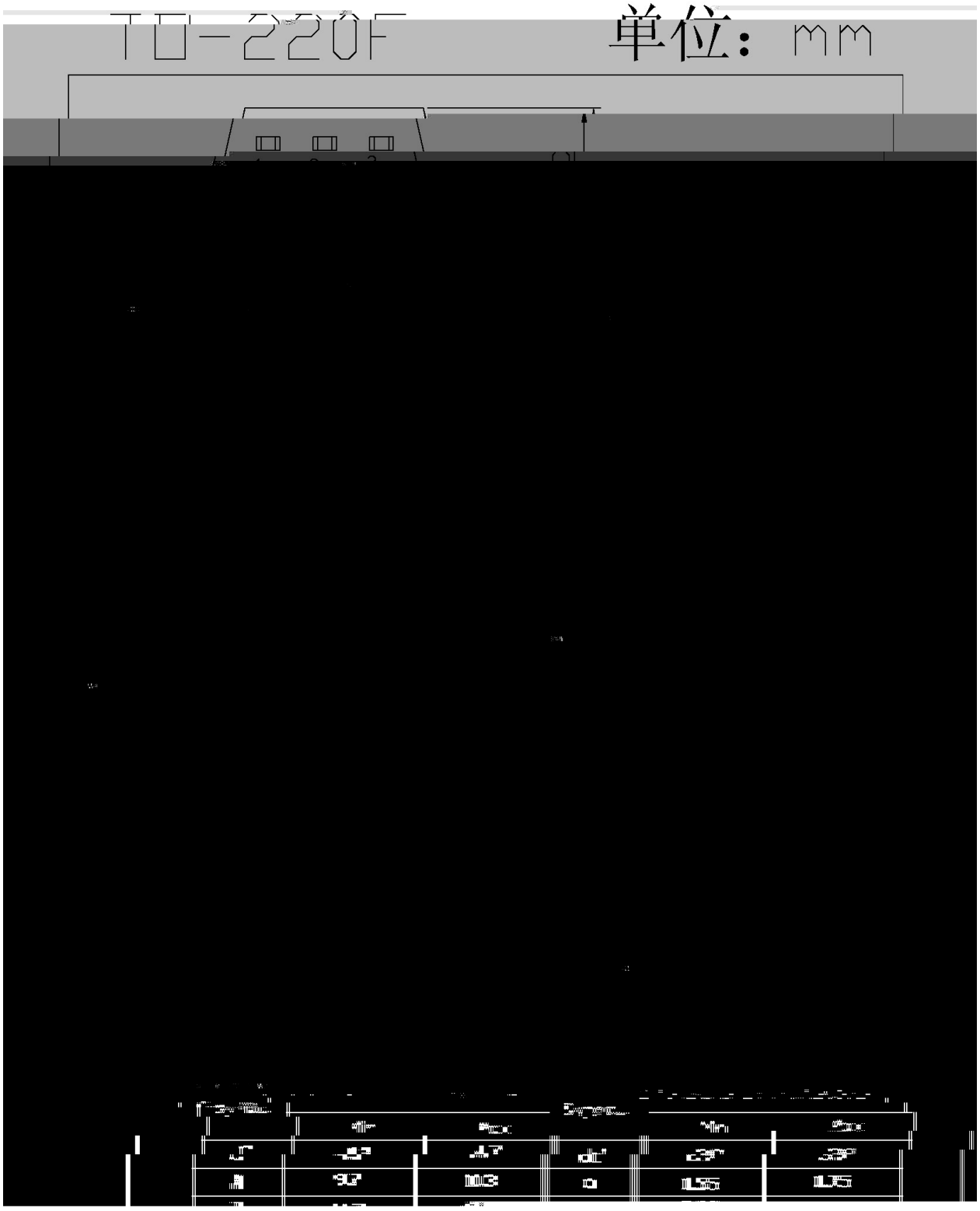
Ô ? d • Ž ¢ / Electrical Characteristic Curve



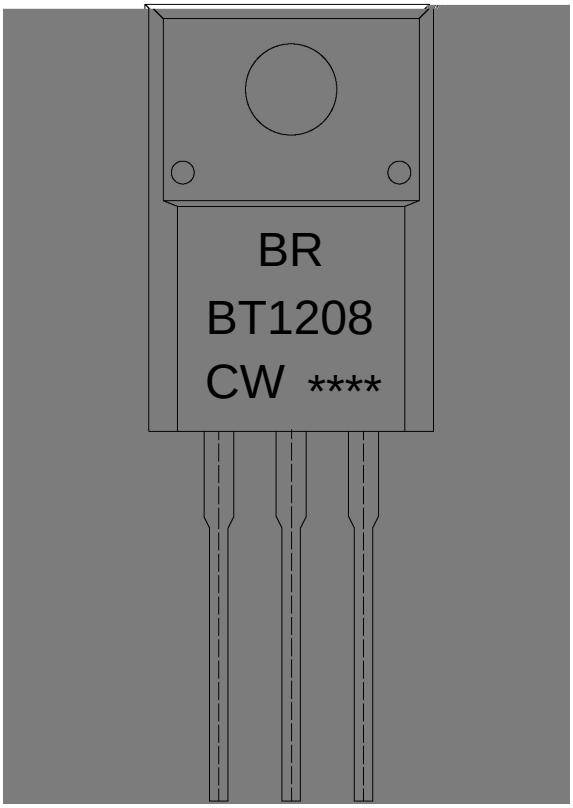




Ø ¤ =) ¢ / Package Dimensions



, M y ƒ / Marking Instructions



ª ¢ y

(8 y ¸ [W A

(: y º Z W A

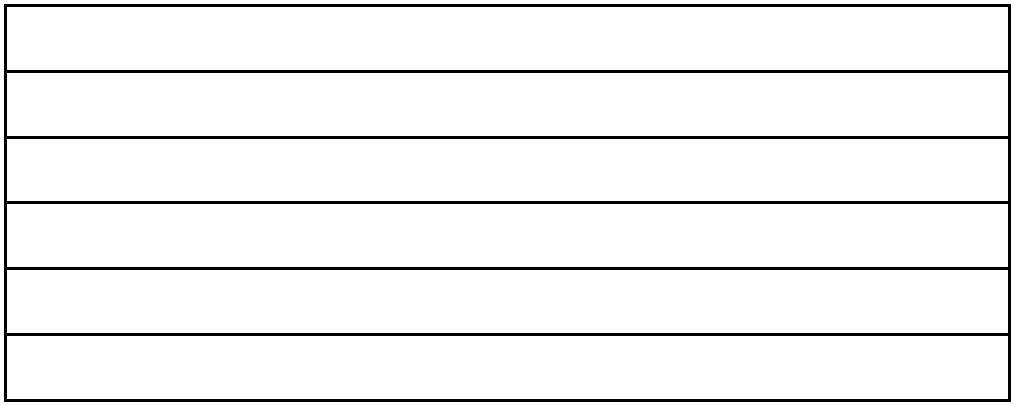
) = y -: ã ⁄W A

y ÿ D Z W A k š ÿ D Z J

Note:

BR:	Company Code
BT1208:	Product Type Code
CW:	I_{GT} Bracket code
****:	Lot No. Code, code change with Lot No

G PD t … • Ž ¢ (x /) / Temperature Profile for Dip Soldering(Pb-Free)



ª ¢ y

1o• Ä ½ “ † 25 ½150 - k ž • 60 ½90sec;

2o• Q › “ † 255 r5 - k ž • 4 Ò 5 r0.5sec;

3o•D N ò i Ò 0 , † 2 ½10 - /sec.

Note:

1.Preheating:25~150 - , Time:60~90sec.

2.Peak Temp.:255 r5 - , Duration:5 r0.5sec.

3. Cooling Speed: 2~10 - /sec.

ÂD /Cã p ¯ »] / Resistance to Soldering Heat Test Conditions

“ † y 270 r5 - ž • y 10 r1 sec. Temp.:270±5 Time:10±1 sec

G P á / Packaging SPEC.

• ^ x / BULK

Package Type 7>û ˜ E	Units ;>û ¦H	Dimension ;>û p .